1 Startup

The photo below shows the output voltage startup waveform after the application of 24V in. The 12V output was loaded to 0A. (5V/DIV, 2mS/DIV)

The photo below shows the output voltage startup waveform after the application of 24V in. The 12V output was loaded to 20A. (5V/DIV, 2mS/DIV)
2 Efficiency

The converter efficiency is shown below.

LM25119 2-Phase Sync Buck Converter, Vin = 24V, Vout = 12V

- Efficiency (%)
- Power Dissipation (W)

Output Current (A)

- Efficiency (%)
- Power Dissipation (W)
3 Output Ripple Voltage

The 12V output ripple voltage (AC coupled) is shown in the figure below. The image was taken with the output loaded to 0A. The input voltage is set to 24V. (20mV/DIV, 2μS/DIV)

![Output Ripple Voltage Graph 1](image1)

The 12V output ripple voltage (AC coupled) is shown in the figure below. The image was taken with the output loaded to 20A. The input voltage is set to 24V. (50mV/DIV, 1μS/DIV)

![Output Ripple Voltage Graph 2](image2)
4 Load Transients

The photo below shows the 12V output voltage (ac coupled) when the load current is stepped between 15A and 20A. Vin = 24V. (100mV/DIV, 10A/DIV, 1mS/DIV)

The photo below shows the 12V output voltage (ac coupled) when the load current is stepped between 10A and 20A. Vin = 24V. (200mV/DIV, 10A/DIV, 1mS/DIV)
The photo below shows the 12V output voltage (ac coupled) when the load current is stepped between 0A and 20A. Vin = 24V.  (500mV/DIV, 10A/DIV, 1mS/DIV)
5 Switch Node Waveforms

The photo below shows the FET switching voltages of each phase for an input voltage of 24V and a 0A load. (5V/DIV, 1μS/DIV)

The photo below shows the FET switching voltages of each phase for an input voltage of 24V and a 20A load. (5V/DIV, 1μS/DIV)
6 Current Balance Waveforms

The photo below shows the measured inductor current in each phase. The input voltage was set to 24V with a 20A load. (2A/DIV, 1uS/DIV)

The photo below shows the measured inductor current in each phase. The input voltage was set to 24V with a 10A load. (2A/DIV, 1uS/DIV)
The photo below shows the measured inductor current in each phase. The input voltage was set to 24V with a 0A load. (2A/DIV, 1uS/DIV)
7 Loop Gain

The plot below shows the loop gain with the input voltage set to 24V and for an output load of 20A.

Loop Gain (Vin = 24V)  BW: 10.1KHz  PM: 57 degrees

The plot below shows the loop gain with the input voltage set to 24V and for an output load of 10A.

Loop Gain (Vin = 24V)  BW: 9.95KHz  PM: 58 degrees
The plot below shows the loop gain with the input voltage set to 24V and for an output load of 0A.

Loop Gain (Vin = 24V)  BW: 8.75KHz  PM: 66 degrees
8 Photo
The photo below shows the PMP20021 REVA assy built on the LM25119 EVM.
A thermal image is shown below operating at 24V input and 12V@20A output (room temp, no airflow).
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